LITE-ON SEMICONDUCTOR

Customer Notification of Product/Process Changes

Page: 1/1

*PCN No.: 16015

*Issued Date: May 3 2016

*Subject: DO15 SIDAC add assembly site ML

*Effective date: Aug 3 2016

*Affected category:

DO15 package

*Affected family: SIDAC

Change Item	☐Material ☐ Design ☐ Process █Others	
Impact Item	1. Product P/N :☐ Yes ■ No	3. Label : □ Yes ■ N o
	2. Marking : Yes No	4. Other items : ☐ Yes ■ No
Other Related Item		
Change Purpose	Add assembly site ML	
	Before Change	After Change
Description of Change	Assembly site Seefull	Assembly site Seefull &ML
·		
Relevant	☐ Electrical Test Report (as the attachment) Mechanical Test Report (as the attachment)	
Verification		
Report	Others (ex. Impacted part list) (as the attachment)	
Other Related Report	Hirel report	¥
Sample availability	■ Yes □No	
Customer	☐ Approve	
Approval	☐ Disapprove	
Customer Requirement (ex. Last Buy requirement)		
d		

Note:

- (1.) If you need sample(s) or any question, please contact with our Salesperson within 30day
- (2.) PCN for customer notification/response, ref. JEDEC No. 46 sec 3.2.3 to implement.

Ouality Assurance